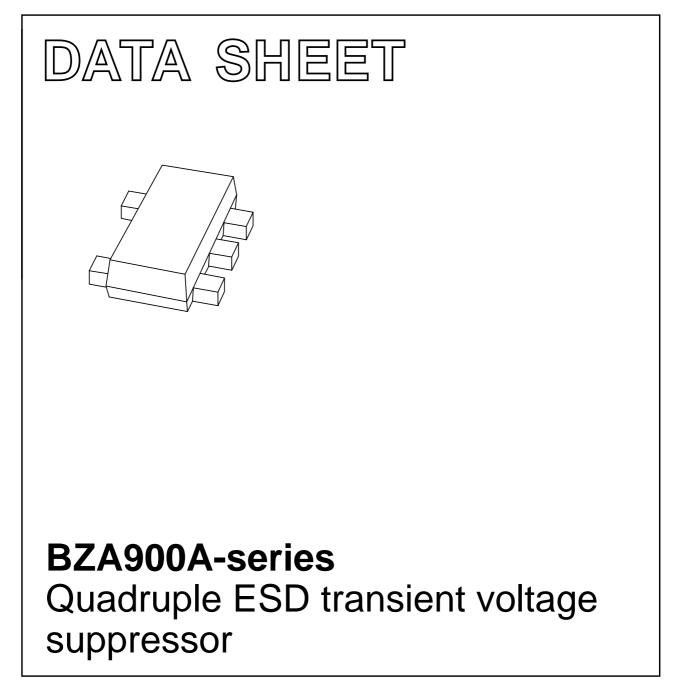
DISCRETE SEMICONDUCTORS



Product specification

2001 Sep 03





BZA900A-series

FEATURES

- ESD rating >8 kV, according to IEC61000-4-2
- SOT665 surface mount package
- Common anode configuration.

APPLICATIONS

- Computers and peripherals
- · Audio and video equipment
- Communication systems

DESCRIPTION

Monolithic transient voltage suppressor diode in a five lead SOT665 package for 4-bit wide ESD transient suppression.

MARKING

TYPE NUMBER	MARKING CODE
BZA956A	Z1
BZA962A	Z2
BZA968A	Z3

PINNING				
PIN	DESCRIPTION			
1	cathode 1			
2	common anode			
3	cathode 2			
4	cathode 3			
5	cathode 4			

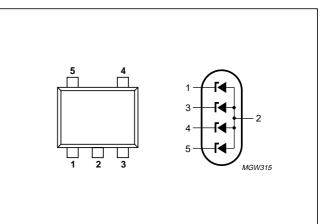


Fig.1 Simplified outline (SOT665) and symbol.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per diode		-			
Iz	working current	T _{amb} = 25 °C	-	note 1	mA
l _F	continuous forward current	T _{amb} = 25 °C	-	200	mA
I _{FSM}	non-repetitive peak forward current	t _p = 1 ms; square pulse	-	4	A
P _{tot}	total power dissipation	T _{amb} = 25 °C; note 2; see Fig.5	-	335	mW
P _{ZSM}	non repetitive peak reverse power dissipation:	square pulse; t _p = 1 ms; see Fig.3			
	BZA956A		-	16	W
	BZA962A		-	15	W
	BZA968A		-	14	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C

Notes

- 1. DC working current limited by $P_{tot(max)}$.
- 2. Device mounted on standard printed-circuit board.

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	all diodes loaded	370	K/W
R _{th j-s}	thermal resistance from junction to solder	one diode loaded	135	K/W
	point; note 1	all diodes loaded	125	K/W

Note

1. Solder point of common anode (pin 2).

ELECTRICAL CHARACTERISTICS

 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT
V _F	forward voltage	I _F = 200 mA	1.3	V
I _R	reverse current			
	BZA956A	$V_R = 3 V$	1000	nA
	BZA962A	$V_R = 4 V$	500	nA
	BZA968A	V _R = 4.3 V	100	nA

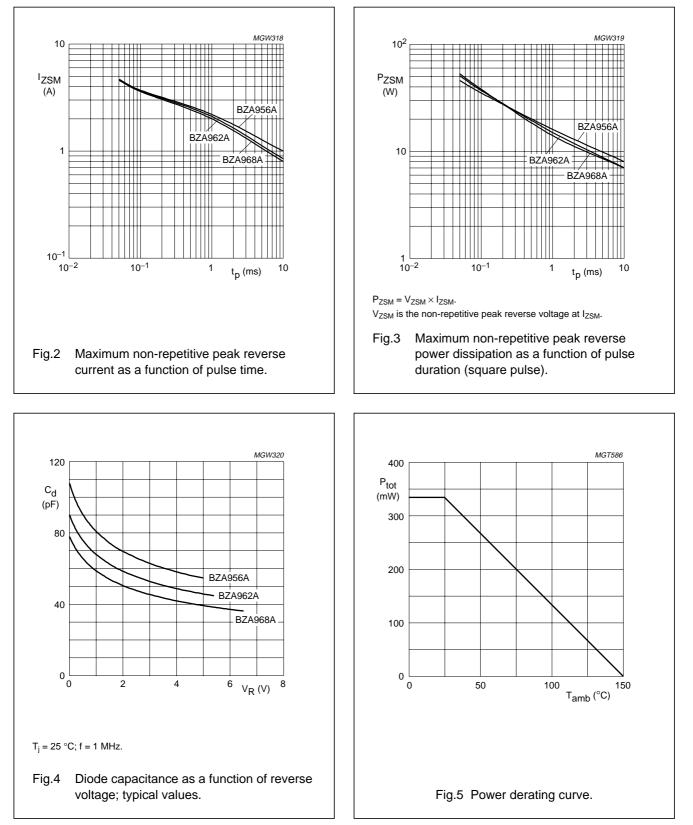
Table 1Per type; BZ956A to BZA968A

 $T_j = 25 \ ^{\circ}C$ unless otherwise specified.

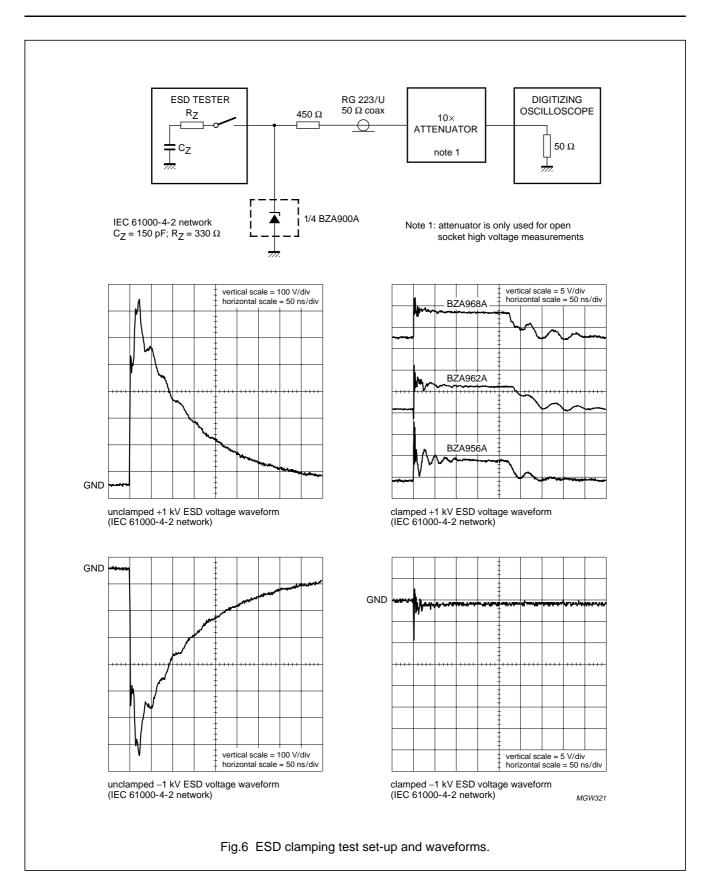
TYPE	WORKING VOLTAGE V _Z (V) at I _Z = 1 mA		DIFFERENTIAL RESISTANCE r _{dif} (Ω) at I _Z = 1 mA	TEMP. COEFF. S _Z (mV/K) at I _Z = 1 mA	DIODE CAP. $C_d (pF)$ at f = 1 MHz; $V_R = 0$	NON-REPETITIVE PEAK REVERSE CURRENT I_{ZSM} (A) at $t_p = 1 ms$; $T_{amb} = 25 °C$	
	MIN.	TYP.	MAX.	MAX.	TYP.	MAX.	MAX.
BZA956A	5.32	5.6	5.88	400	0.3	125	2.2
BZA962A	5.89	6.2	6.51	300	1.6	105	2.1
BZA968A	6.46	6.8	7.14	200	2.2	90	2.0

BZA900A-series

GRAPHICAL DATA



BZA900A-series

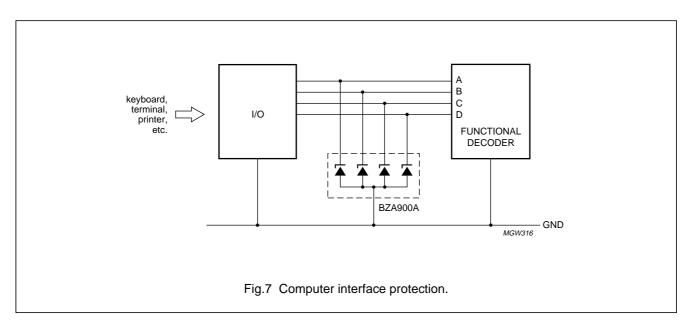


BZA900A-series

APPLICATION INFORMATION

Typical common anode application

A quadruple transient suppressor in a SOT665 package makes it possible to protect four separate lines using only one package. A simplified example is shown in Fig.7.



Device placement and printed-circuit board layout

Circuit board layout is of extreme importance in the suppression of transients. The clamping voltage of the BZA900A is determined by the peak transient current and the rate of rise of that current (di/dt). Since parasitic inductances can further add to the clamping voltage (V = L di/dt) the series conductor lengths on the printed-circuit board should be kept to a minimum. This includes the lead length of the suppression element.

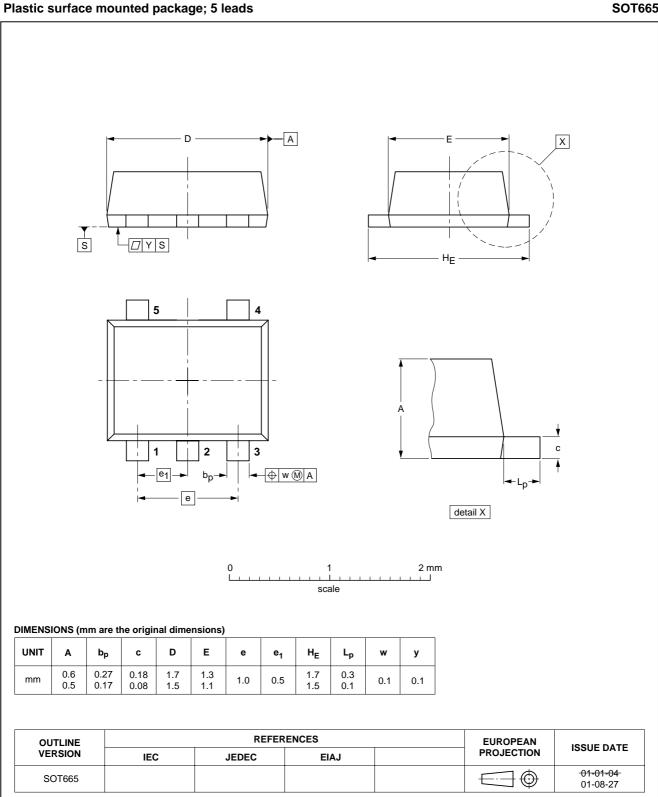
In addition to minimizing conductor length the following printed-circuit board layout guidelines are recommended:

- 1. Place the suppression element close to the input terminals or connectors
- 2. Keep parallel signal paths to a minimum
- 3. Avoid running protection conductors in parallel with unprotected conductors
- 4. Minimize all printed-circuit board loop areas including power and ground loops
- 5. Minimize the length of the transient return path to ground
- 6. Avoid using shared transient return paths to a common ground point.

BZA900A-series

Quadruple ESD transient voltage suppressor

PACKAGE OUTLINE



BZA900A-series

DATA SHEET STATUS

DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A.

Notes

- 1. Please consult the most recently issued data sheet before initiating or completing a design.
- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

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Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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